ON Semiconductor

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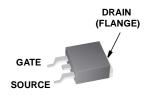
ON Semiconductor®

HUF76639S3ST-F085

50A, 100V, 0.026 Ohm, N-Channel, Logic Level UltraFET® Power MOSFET

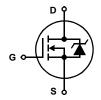
Packaging

JEDEC TO-263AB



HUF76639S3S

Symbol





Features

- Ultra Low On-Resistance
 - $r_{DS(ON)} = 0.026\Omega$, $V_{GS} = 10V$
- Simulation Models
 - Temperature Compensated PSPICE® and SABER™ Electrical Models
 - Spice and SABER Thermal Impedance Models
 - www.fairchildsemi.com
- Peak Current vs Pulse Width Curve
- · UIS Rating Curve
- Switching Time vs R_{GS} Curves

Ordering Information

PART NUMBER	PACKAGE	BRAND		
HUF76639S3ST-F085	TO-263AB	76639S		

NOTE: When ordering, use the entire part number. Add the suffix T to obtain the variant in tape and reel, e.g., ${\sf HUF76639S3ST}$.

Absolute Maximum Ratings $T_C = 25^{\circ}C$, Unless Otherwise Specified

	HUF76639S3ST_F085	UNITS
Drain to Source Voltage (Note 1)V _{DSS}	100	V
Drain to Gate Voltage ($R_{GS} = 20k\Omega$) (Note 1)	100	V
Gate to Source Voltage	±16	V
Drain Current		
Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 5V$)	50	Α
Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$) (Figure 2)	51	Α
Continuous ($T_C = 100^{\circ}$ C, $V_{GS} = 5$ V)	35	Α
Continuous ($T_C = 100^{\circ}$ C, $V_{GS} = 4.5$ V) (Figure 2)	34	Α
Pulsed Drain Current	Figure 4	
Pulsed Avalanche RatingUIS	Figures 6, 17, 18	
Power Dissipation	180	W
Derate Above 25°C	1.2	W/ ^o C
Operating and Storage Temperature	-55 to 175	°C
Maximum Temperature for Soldering		
Leads at 0.063in (1.6mm) from Case for 10s	300	°C
Package Body for 10s, See Techbrief TB334	260	οС
NOTES:		

1. $T_{.1} = 25^{\circ}C$ to $150^{\circ}C$.

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

HUF76639S3ST-F085

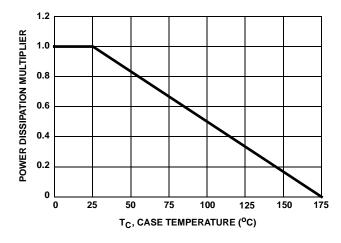
Electrical Specifications $T_C = 25^{\circ}C$, Unless Otherwise Specified

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN	TYP	MAX	UNITS
OFF STATE SPECIFICATIONS	*			*			
Drain to Source Breakdown Voltage	BV _{DSS} $I_D = 250\mu A, V_{GS} = 0V$		0V (Figure 12)	100	-	-	V
		$I_D = 250 \mu A, V_{GS} = 0$	0V , T _C = -40 ^o C (Figure 12)	90	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 95V, V_{GS} = 0$	V	-	-	1	μΑ
		V _{DS} = 90V, V _{GS} = 0	OV, T _C = 150 ^o C	-	-	250	μΑ
Gate to Source Leakage Current	I _{GSS}	V _{GS} = ±16V		-	-	±100	nA
ON STATE SPECIFICATIONS							
Gate to Source Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D} = 250\mu A \text{ (Figure 11)}$		1	-	3	V
Drain to Source On Resistance	r _{DS(ON)}	I _D = 51A, V _{GS} = 10V (Figures 9, 10)		-	0.023	0.026	Ω
THERMAL SPECIFICATIONS							
Thermal Resistance Junction to Case	$R_{ heta JC}$	TO-263		-	-	0.83	oC/W
Thermal Resistance Junction to Ambient	$R_{\theta JA}$			-	-	62	oC/W
SWITCHING SPECIFICATIONS (VGS	= 4.5V)						
Turn-On Time	ton	V _{DD} = 50V, I _D = 34	A	-	-	336	ns
Turn-On Delay Time	t _d (ON)	V _{GS} = 4.5V, R _{GS} =		-	17	-	ns
Rise Time	t _r	(Figures 15, 21, 22)		-	207	-	ns
Turn-Off Delay Time	t _{d(OFF)}			-	83	-	ns
Fall Time	t _f			-	136	-	ns
Turn-Off Time	tOFF			-	-	328	ns
SWITCHING SPECIFICATIONS (VGS	_				1		
Turn-On Time	ton	$V_{DD} = 50V, I_{D} = 51A$ $V_{GS} = 10V, R_{GS} = 12\Omega$ (Figures 16, 21, 22)		-	-	96	ns
Turn-On Delay Time	t _d (ON)			-	10	-	ns
Rise Time	t _r			-	55	-	ns
Turn-Off Delay Time	t _{d(OFF)}			-	151	-	ns
Fall Time	t _f			-	110	-	ns
Turn-Off Time	tOFF			-	-	392	ns
GATE CHARGE SPECIFICATIONS					1		1
Total Gate Charge	Q _{g(TOT)}	$V_{GS} = 0V \text{ to } 10V$	$V_{DD} = 50V$,	-	71	86	nC
Gate Charge at 5V	Q _{g(5)}	$V_{GS} = 0V \text{ to } 5V$	$I_D = 35A,$ $I_{g(REF)} = 1.0mA$ (Figures 14, 19, 20)	-	39	47	nC
Threshold Gate Charge	Q _{g(TH)}	V _{GS} = 0V to 1V		-	2.0	2.4	nC
Gate to Source Gate Charge	Q _{gs}	(. iguido 14, 10, 20)	-	6	-	nC	
Gate to Drain "Miller" Charge	Q _{gd}			-	19	-	nC
CAPACITANCE SPECIFICATIONS	-	1	'	1		1	1
Input Capacitance	C _{ISS}	$V_{DS} = 25V, V_{GS} = 0V,$ $f = 1MHz$ (Figure 13)		-	2400	-	pF
Output Capacitance	C _{OSS}			-	520	-	pF
Reverse Transfer Capacitance	C _{RSS}			-	140	-	pF

Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Source to Drain Diode Voltage	V_{SD}	I _{SD} = 35A	-	-	1.25	V
		I _{SD} = 15A	-	-	1.0	V
Reverse Recovery Time	t _{rr}	$I_{SD} = 35A$, $dI_{SD}/dt = 100A/\mu s$	-	-	137	ns
Reverse Recovered Charge	Q _{RR}	$I_{SD} = 35A$, $dI_{SD}/dt = 100A/\mu s$	-	-	503	nC

Typical Performance Curves



60 50 ID, DRAIN CURRENT (A) V_{GS} = 10V 40 $V_{GS} = 4.5V$ 30 20 10 0 50 75 100 125 150 25 175 T_C, CASE TEMPERATURE (°C)

FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

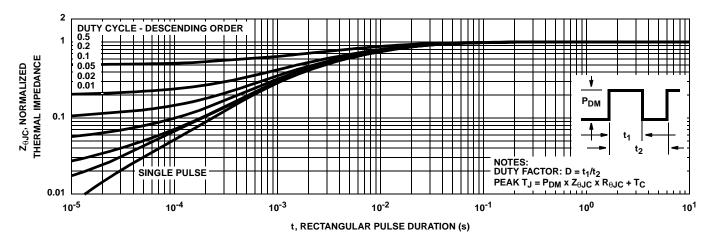


FIGURE 3. NORMALIZED MAXIMUM TRANSIENT THERMAL IMPEDANCE

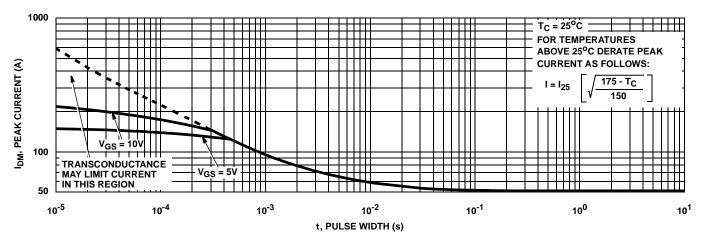


FIGURE 4. PEAK CURRENT CAPABILITY

Typical Performance Curves (Continued)

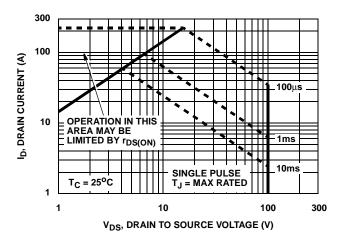


FIGURE 5. FORWARD BIAS SAFE OPERATING AREA

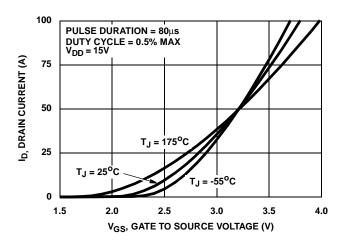


FIGURE 7. TRANSFER CHARACTERISTICS

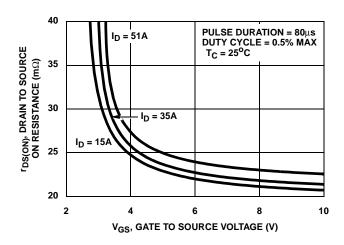


FIGURE 9. DRAIN TO SOURCE ON RESISTANCE vs GATE VOLTAGE AND DRAIN CURRENT

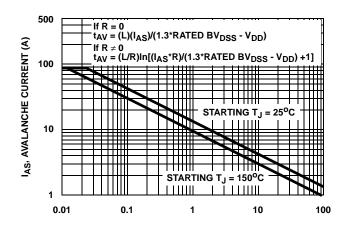


FIGURE 6. UNCLAMPED INDUCTIVE SWITCHING CAPABILITY

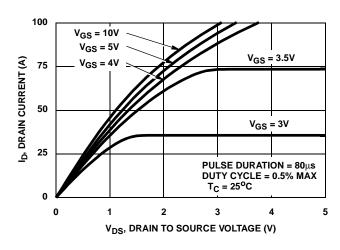


FIGURE 8. SATURATION CHARACTERISTICS

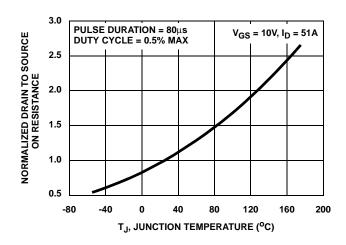


FIGURE 10. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

Typical Performance Curves (Continued)

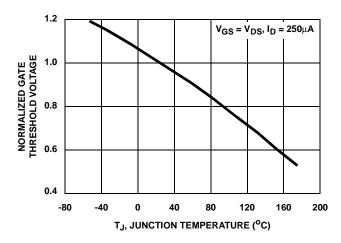


FIGURE 11. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

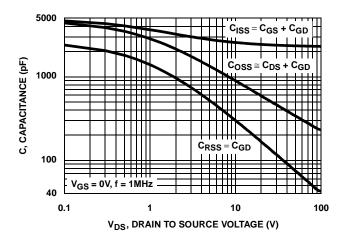


FIGURE 13. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE

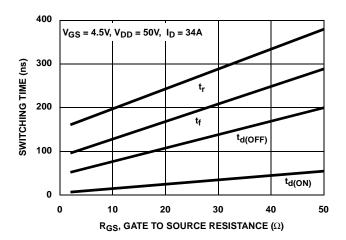


FIGURE 15. SWITCHING TIME vs GATE RESISTANCE

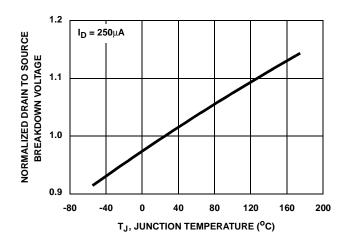


FIGURE 12. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE

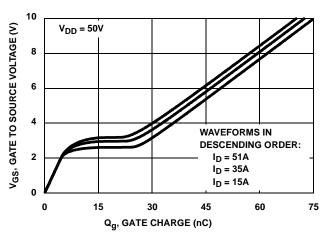


FIGURE 14. GATE CHARGE WAVEFORMS FOR CONSTANT

GATE CURRENT

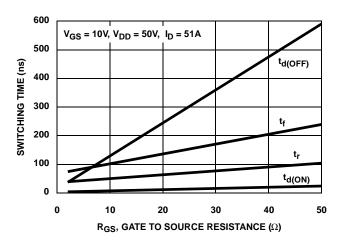


FIGURE 16. SWITCHING TIME vs GATE RESISTANCE

Test Circuits and Waveforms

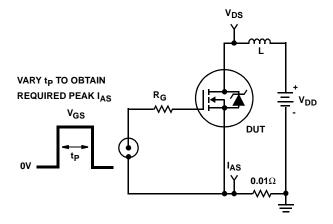


FIGURE 17. UNCLAMPED ENERGY TEST CIRCUIT

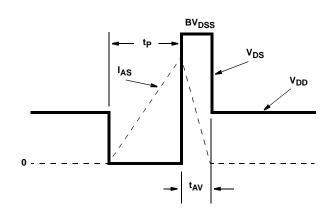


FIGURE 18. UNCLAMPED ENERGY WAVEFORMS

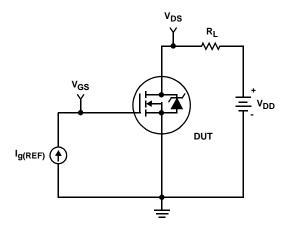


FIGURE 19. GATE CHARGE TEST CIRCUIT

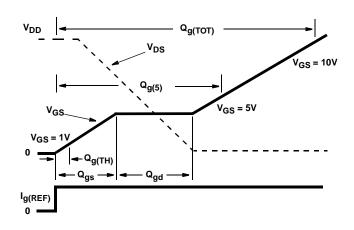


FIGURE 20. GATE CHARGE WAVEFORMS

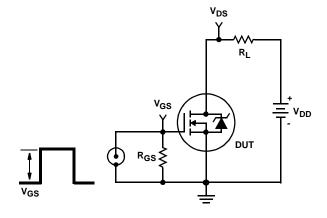


FIGURE 21. SWITCHING TIME TEST CIRCUIT

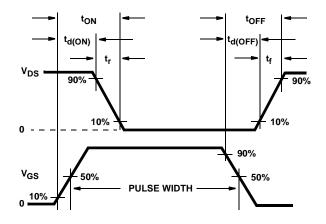


FIGURE 22. SWITCHING TIME WAVEFORM

PSPICE Electrical Model

```
.SUBCKT HUF76639 2 1 3;
                                  rev 26 July 1999
CA 12 8 4.2e-9
CB 15 14 4.2e-9
CIN 6 8 2.27e-9
DBODY 7 5 DBODYMOD
DBREAK 5 11 DBREAKMOD
                                                                                                                 LDRAIN
DPLCAP 10 5 DPLCAPMOD
                                                                     DPLCAP
                                                                                5
                                                                                                                            DRAIN
EBREAK 11 7 17 18 118.2
                                                                 10
EDS 148581
                                                                                                                 RLDRAIN
                                                                                €RSLC1
EGS 13 8 6 8 1
                                                                                               DBREAK '
ESG 6 10 6 8 1
                                                                                 51
                                                                   RSLC<sub>2</sub>
EVTHRES 6 21 19 8 1
EVTEMP 20 6 18 22 1
                                                                                    ESLC
                                                                                                       11
IT 8 17 1
                                                                                 50
                                                                                                        17
18
                                                                                                                DBODY
                                                                                 RDRAIN
LDRAIN 2 5 1.0e-9
                                                                                              EBREAK
                                                          ESG
LGATE 1 9 5.1e-9
                                                                      EVTHRES
                                                                                     16
LSOURCE 3 7 3.1e-9
                                                                                 21
                                                                        19
8
                                                                                                MWEAK
                                       LGATE
                                                        EVTEMP
MMED 16 6 8 8 MMEDMOD
                                                RGATE
                               GATE
                                                                                   11-
MSTRO 16 6 8 8 MSTROMOD
                                                                                       MMED
                                                           22
                                                9
                                                       20
MWEAK 16 21 8 8 MWEAKMOD
                                                                                MSTRC
                                       RLGATE
RBREAK 17 18 RBREAKMOD 1
                                                                                                                 LSOURCE
                                                                           CIN
                                                                                                                           SOURCE
RDRAIN 50 16 RDRAINMOD 15.8e-3
                                                                                     8
                                                                                                                              3
RGATE 9 20 1.94
                                                                                                RSOURCE
RLDRAIN 2 5 10
                                                                                                                RLSOURCE
RLGATE 1 9 51
RLSOURCE 3 7 31
                                                         S1A
                                                                                                    RBREAK
                                                       12 I
RSI C1 5 51 RSI CMOD 1e-6
                                                            <u>13</u>
8
                                                                  14
13
                                                                          15
                                                                                                17
RSLC2 5 50 1e3
RSOURCE 8 7 RSOURCEMOD 3.6e-3
                                                         S1B
                                                                   o S2B
                                                                                                               RVTFMP
RVTHRES 22 8 RVTHRESMOD 1
                                                                13
                                                                           СВ
RVTEMP 18 19 RVTEMPMOD 1
                                                                                                               19
                                                   CA
                                                                                              IT
                                                                                14
S1A 6 12 13 8 S1AMOD
                                                                                                                VBAT
S1B 13 12 13 8 S1BMOD
                                                            EGS
                                                                        EDS
S2A 6 15 14 13 S2AMOD
                                                                                             8
S2B 13 15 14 13 S2BMOD
                                                                                                              22
                                                                                                    RVTHRES
VBAT 22 19 DC 1
ESLC 51 50 VALUE = \{(V(5,51)/ABS(V(5,51)))^*(PWR(V(5,51)/(1e-6*99),3.5))\}
.MODEL DBODYMOD D (IS = 2.6e-12 RS = 2.65e-3 IKF = 6 TRS1 = 1.5e-3 TRS2 = 3.5e-6 CJO = 2.1e-9 TT = 5.6e-8 M = 0.52)
.MODEL DBREAKMOD D (RS = 2.5e-1 TRS1 = 1e-4 TRS2 = -1e-6)
.MODEL DPLCAPMOD D (CJO = 2.6e-9 IS = 1e-30 M = 0.89 N = 10)
.MODEL MMEDMOD NMOS (VTO = 1.77 KP = 7 IS = 1e-30 N = 10 TOX = 1 L = 1U W = 1U RG = 1.94)
.MODEL MSTROMOD NMOS (VTO = 2.06 \text{ KP} = 95 \text{ IS} = 1e-30 \text{ N} = 10 \text{ TOX} = 1 \text{ L} = 10 \text{ W} = 10)
.MODEL MWEAKMOD NMOS (VTO = 1.48 KP = 0.12 IS = 1e-30 N = 10 TOX = 1 L = 1U W = 1U RG = 19.4 RS = .1)
.MODEL RBREAKMOD RES (TC1 = 1.05e-3 TC2 = -5e-7)
.MODEL RDRAINMOD RES (TC1 = 8.5e-3 TC2 = 2.3e-5)
.MODEL RSLCMOD RES (TC1 = 3.4e-3 TC2 = 2.5e-6)
.MODEL RSOURCEMOD RES (TC1 = 1e-3 TC2 = 1e-6)
.MODEL RVTHRESMOD RES (TC1 = -1.9e-3 TC2 = -4.5e-6)
.MODEL RVTEMPMOD RES (TC1 = -1.7e-3 TC2 = 1.5e-6)
.MODEL S1AMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -4.5 VOFF = -2.0)
.MODEL S1BMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -2.0 VOFF = -4.5)
```

NOTE: For further discussion of the PSPICE model, consult A New PSPICE Sub-Circuit for the Power MOSFET Featuring Global Temperature Options; IEEE Power Electronics Specialist Conference Records, 1991, written by William J. Hepp and C. Frank Wheatley.

.MODEL S2AMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -0.5 VOFF = 0.3) .MODEL S2BMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = 0.3 VOFF = -0.5)

FNDS

SABER Electrical Model

```
REV 26 July 1999
template huf76639 n2,n1,n3
electrical n2,n1,n3
var i iscl
d..model dbodymod = (is = 2.6e-12, cjo = 2.1e-9, tt = 5.6e-8, m = 0.52, n=10)
d..model dbreakmod = ()
d..model dplcapmod = (cjo = 2.6e-9, is = 1e-30, m = 0.89)
m..model mmedmod = (type=_{n}, vto = 1.77, kp = 7, is = 1e-30, tox = 1)
m..model mstrongmod = (type=_n, vto = 2.06, kp = 95, is = 1e-30, tox = 1)
m..model mweakmod = (type=_n, vto = 1.48, kp = 0.12, is = 1e-30, tox = 1)
                                                                                                                                 LDRAIN
sw_vcsp..model s1amod = (ron = 1e-5, roff = 0.1, von = -4.5, voff = -2.0)
                                                                                  DPLCAP
                                                                                                                                            DRAIN
sw vcsp..model s1bmod = (ron = 1e-5, roff = 0.1, von = -2.0, voff = -4.5)
                                                                               10
sw_vcsp..model s2amod = (ron = 1e-5, roff = 0.1, von = -0.5, voff = 0.3)
                                                                                                                                RLDRAIN
sw_vcsp..model s2bmod = (ron = 1e-5, roff = 0.1, von = 0.3, voff = -0.5)
                                                                                               RSLC1
                                                                                                           RDBREAK
c.ca n12 n8 = 4.2e-9
                                                                                RSLC2 €
                                                                                                                    72
c.cb n15 n14 = 4.2e-9
                                                                                                                                RDBODY
                                                                                                 ISCL
c.cin n6 n8 = 2.27e-9
                                                                                                             DBREAK 1
d.dbody n7 n71 = model = dbodymod
                                                                                               RDRAIN
d.dbreak n72 n11 = model = dbreakmod
                                                                            6
8
                                                                      ESG
                                                                                                                      11
d.dplcap n10 n5 = model = dplcapmod
                                                                                   EVTHRES
                                                                                                   16
                                                                                               21
                                                                                      \left(\frac{19}{8}\right)
                                                                                                               MWEAK
i.it n8 n17 = 1
                                                   LGATE
                                                                     EVTEMP
                                                                                                                                DBODY
                                                             RGATE
                                          GATE
                                                                                6
                                                                                                                EBREAK
I.ldrain n2 n5 = 1.0e-9
                                                                                                     MMED
                                                            9
                                                                   20
1.lgate n1 n9 = 5.1e-9
                                                                                          ←MSTR
                                                  RLGATE
I.Isource n3 n7 = 3.1e-9
                                                                                                                                LSOURCE
                                                                                         CIN
                                                                                                                                           SOURCE
                                                                                                   8
m.mmed n16 n6 n8 n8 = model = mmedmod, I = 1u, w = 1u
m.mstrong n16 n6 n8 n8 = model = mstrongmod, I = 1u, w = 1u
                                                                                                              RSOURCE
m.mweak n16 n21 n8 n8 = model = mweakmod, I = 1u, w = 1u
                                                                                                                               RLSOURCE
                                                                                o S2A
res.rbreak n17 n18 = 1, tc1 = 1.05e-3, tc2 = -5e-7
                                                                                                                   RBREAK
                                                                          13
8
res.rdbody n71 n5 = 2.65e-3, tc1 = 1.5e-3, tc2 = 3.5e-6
                                                                                                               17
res.rdbreak n72 n5 = 2.5e-1, tc1 = 1e-4, tc2 = -1e-6
                                                                                                                              RVTEMP
res.rdrain n50 n16 = 15.8e-3, tc1 = 8.5e-3, tc2 = 2.3e-5
                                                                                o S2B
res.rgate n9 n20 = 1.94
                                                                                        CB
                                                               CA
res.rldrain n2 n5 = 10
                                                                                                             ΙT
res.rlgate n1 n9 = 51
                                                                                                                                VBAT
res.rlsource n3 n7 = 31
                                                                         EGS
                                                                                     EDS
res.rslc1 n5 n51 = 1e-6, tc1 = 3.4e-3, tc2 = 2.5e-6
                                                                                                           8
res.rslc2 n5 n50 = 1e3
res.rsource n8 n7 = 3.6e-3, tc1 = 1e-3, tc2 = 1e-6
                                                                                                                  RVTHRES
res.rvtemp n18 n19 = 1, tc1 = -1.7e-3, tc2 = 1.5e-6
res.rvthres n22 n8 = 1, tc1 = -1.9e-3, tc2 = -4.5e-6
spe.ebreak n11 n7 n17 n18 = 118.2
^{\circ} spe.eds n14 n8 n5 n8 = 1
spe.egs n13 n8 n6 n8 = 1
spe.esg n6 n10 n6 n8 = 1
spe.evtemp n20 n6 n18 n22 = 1
spe.evthres n6 n21 n19 n8 = 1
sw_vcsp.s1a n6 n12 n13 n8 = model = s1amod
sw_vcsp.s1b n13 n12 n13 n8 = model = s1bmod
sw_vcsp.s2a n6 n15 n14 n13 = model = s2amod
sw_vcsp.s2b n13 n15 n14 n13 = model = s2bmod
v.vbat n22 n19 = dc = 1
equations {
i(n51->n50) + = iscl
iscl: v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))*((abs(v(n5,n51)*1e6/99))** 3.5))
```

SPICE Thermal Model

REV 26 July 1999

HUF76639T

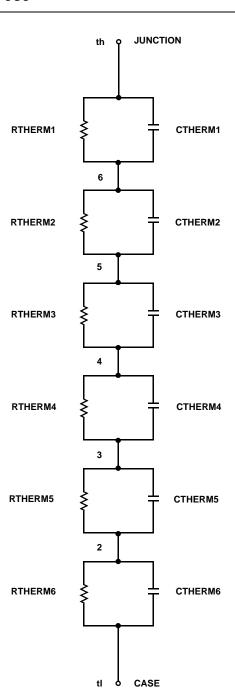
CTHERM1 th 6 3.2e-3
CTHERM2 6 5 8.5e-3
CTHERM3 5 4 1.2e-2
CTHERM4 4 3 1.6e-2
CTHERM5 3 2 5.5e-2
CTHERM6 2 tl 1.5

RTHERM1 th 6 8.0e-3
RTHERM2 6 5 6.8e-2
RTHERM3 5 4 9.2e-2
RTHERM4 4 3 2.0e-1
RTHERM5 3 2 2.4e-1
RTHERM6 2 tl 5.2e-2

SABER Thermal Model

SABER thermal model HUF76639T

```
template thermal_model th tl thermal_c th, tl { ctherm.ctherm1 th 6=3.2e\text{-}3 ctherm.ctherm2 6.5=8.5e\text{-}3 ctherm.ctherm3 5.4=1.2e\text{-}2 ctherm.ctherm4 4.3=1.6e\text{-}2 ctherm.ctherm5 3.2=5.5e\text{-}2 ctherm.ctherm6 2.tl=1.5 rtherm.rtherm1 th 6=8.0e\text{-}3 rtherm.rtherm2 6.5=6.8e\text{-}2 rtherm.rtherm3 5.4=9.2e\text{-}2 rtherm.rtherm4 5.2e\text{-}2 rtherm.rtherm6 5.2e\text{-}2 rtherm.rtherm6 5.2e\text{-}2 rtherm.rtherm6 5.2e\text{-}2 rtherm.rtherm6 5.2e\text{-}2
```



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